

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	659	257/622	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/08 12:12
L2	706	257/620	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/08 13:11
L3	735	257/635	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/08 13:12
L4	15	257/E23.179	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/08 13:13
L5	1	257/E21.122	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/08 13:13
S1	4898	257/758	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/10/25 19:51
S2	7307	wafer same (peripheral or edge) with (recess or open\$3 or via or aperture or hole or cavity)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/25 18:48
S3	4572	wafer with (peripheral or edge) with (recess or open\$3 or via or aperture or hole or cavity)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/25 18:49
S4	571	wafer with (peripheral or edge) with (recess or open\$3 or via or aperture or hole or cavity) and (dielectric or insulat\$3) with (peripheral or edge)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/25 18:52

S5	95	(wafer with (peripheral or edge) with (recess or open\$3 or via or aperture or hole or cavity) and (dielectric or insulat\$3) with (peripheral or edge)) and wafer with multi\$3	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2004/10/25 18:52
S6	972	257/759	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/10/25 20:08
S7	1259	257/760	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/10/25 20:12
S8	479	257/761	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/10/25 20:33
S9	1486	257/762	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/10/25 20:37
S10	2626	257/751	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/10/25 21:17
S11	3219	dielectric near constant with (silicon near nitride or "Si" near "N")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/10/25 20:46
S12	1233	257/754	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/10/25 21:26
S13	847	257/755	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/10/25 21:29
S14	424	257/756	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/10/25 21:36

S15	737	257/757	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/10/25 21:37
S16	3360	174/261	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/10/25 22:55
S17	1265	174/256	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/10/25 23:05
S18	1062	174/257	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2004/10/25 23:05
S19	4646	257/758	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/04 10:50
S21	2056	257/758 and wafer	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/04 10:50
S22	2056	257/758 and wafer	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/04 10:50
S23	338	257/758 and wafer	US-PGPUB	OR	OFF	2005/04/04 10:50
S24	1718	257/758 and wafer	USPAT	OR	OFF	2005/04/05 12:47
S25	1	"06244405"	JPO	OR	OFF	2005/04/04 12:53
S26	4658	257/758	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/05 13:32
S27	981	257/759	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/05 14:31

S28	1161	257/760	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/05 14:52
S29	357	257/761	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/05 14:58
S30	1305	257/762	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/05 15:05
S31	884	257/754	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/05 15:19
S32	484	257/755	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/05 15:27
S33	312	257/756	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/05 15:31
S34	511	257/757	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/05 15:34
S35	2	"20030001267"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/05 15:34

S36	2476	257/751	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/05 15:56
S37	2970	174/261	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/05 16:10
S38	1046	174/256	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/05 16:27
S39	708	174/257	USPAT	OR	OFF	2005/04/05 17:05
S40	808	174/257	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/05 17:13
S41	940	174/258	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/05 17:16
S42	2182	174/250	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/05 17:24
S43	5601	428/209	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/05 17:41
S44	1999	428/210	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2005/04/05 17:41